



INVITATION TO SPONSOR
The 10th International Conference on Technological Advances of Thin Films & Surface Coatings (ThinFilms2024)

15 to 19 July, 2024, Singapore

15 July, 2023

Dear Industrial Associates,

The 10th International Conference on Technological Advances of Thin Films & Surface Coatings (ThinFilms2024) will take place from 15 to 19 July, 2024, in Singapore.

The biennial *Thin Films* conference started in 2002 with 70 papers and grew to 500 papers at “ThinFilms2006”, and to more than 800 papers at “ThinFilms2010”, and maintained at that scale in the several subsequent versions. This time we are expecting at least the same crowd, if not more. After the unfortunate disruption due to covid pandemic, ThinFilms2024 will again bring together state-of-the-art developments on all aspects related to the processing, characterization and applications of thin films and surface coatings.

We believe that this is a good opportunity to showcase your latest processing and characterization equipment or apparatus to the researchers/engineers in this region and from the rest of the world. We thus invite you to participate in this exciting materials event in Singapore.

Various sponsorship packages have been designed to suit different needs for maximum impact at this event. To sign up for the conference sponsorship/exhibition or for more information, please contact:

Dr. Guojun Qi, at +0065-94554291 or E-mail: gjq2767@Yahoo.com

Dr. Shiyu Liu, at +0065-87338013 or E-mail: liu_shiyu@amta.a-star.edu.sg

Looking forward to your active participation,

Yours truly,

A handwritten signature in black ink, appearing to be 'Sam Zhang', with a long horizontal line extending to the right.

Professor Sam Zhang
Chairman, ThinFilms2024



SPONSORSHIP & EXHIBITION PACKAGES

Diamond Sponsor (S\$30,000)

- Company Logo (Large size) acknowledgement on:
 - Covers of Technical Program
 - Final Announcement
- Company logo acknowledgement on Conference website and linkage to company website
- Provision to include company's brochures into conference kit
- One-page company advertisement in Technical Program
- Company logo acknowledgement on the conference backdrop in the main ballroom
- Invitation to address at the conference banquet
- Two (2) conference exhibition booths free of charge
- Ten (10) complimentary conference registrations
- Six (6) complimentary tickets to conference banquet
- Max sixteen (16) company staff allowed to man the exhibition booths with complementary lunch and tea break tickets.

Gold Sponsor (S\$20,000)

- Company Logo (Medium size) acknowledgement on:
 - Covers of Technical Program
 - Final Announcement
- Company logo acknowledgement on Conference website and linkage to company website
- Provision to include company's brochures into conference kit
- One-page company advertisement in Technical Program
- Company logo acknowledgement on the conference backdrop in the main ballroom
- Two (2) conference exhibition booths free of charge
- Six (6) complimentary conference registrations
- Four (4) complimentary tickets to conference banquet
- Max ten (10) company staff allowed to man the exhibition booths with complementary lunch and tea break tickets.

Silver Sponsor (S\$10,000)

- Company Logo (Medium size) acknowledgement on:
 - Covers of Technical Program
 - Final Announcement
- Company logo acknowledgement on Conference website and linkage to company website
- Provision to include company's brochures into conference kit
- One (1) conference exhibition booth free of charge

- Three (3) complimentary conference registrations
- Three (3) complimentary tickets to conference banquet
- Max six (6) company staff allowed to man the exhibition booths with complementary lunch and tea break tickets

Bronze Sponsor (S\$6,000)

- Company Logo (Small size) acknowledgement on:
 - Covers of Technical Program
 - Final Announcement
- Company logo acknowledgement on Conference website and linkage to company website
- One (1) conference exhibition booth free of charge
- One (1) complimentary conference registration
- Two (2) complimentary tickets to conference banquet
- Max three (3) company staff allowed to man the exhibition booths with complementary lunch and tea break tickets

Exhibitor (S\$5,000)

- Company logo acknowledgement on Conference website and linkage to company website
- One (1) conference exhibition booth free of charge
- One (1) complimentary ticket to conference banquet
- Max two (2) company staff allowed to man the exhibition booths with complementary lunch and tea break tickets.

A summary of the available sponsorships is shown in the attached table.

Contact:

Dr. Qi Guojun, HP : 65-94554291; Email: gqi2767@yahoo.com

Dr. Shiyu Liu, HP : 65-87338013; E-mail: liu_shiyu@amta.a-star.edu.sg

Summary of the conference sponsorship packages – ThinFilms2024

Sponsorship category	Diamond	Gold	Silver	Bronze	Exhibition
Sponsorship, S\$	30,000	20,000	10,000	6,000	5,000
Company logo acknowledgement on Conference website linkage to company website	★	★	★	★	★
Company Logo acknowledgement on: <ul style="list-style-type: none"> ➤ Covers of Technical Program ➤ Final Announcement 	★ (L-size)	★ (M- size)	★ (M- size)	★ (S- size)	
Provision to include company's brochures into conference kit	★	★	★		
One-page company advertisement in Technical Program	★	★			
Company logo on conference backdrop in the main ballroom	★	★			
Invitation to address the conference banquet	★				
Conference exhibition booth(s) free of charge	2	2	1	1	1
Complimentary conference registrations	10	6	3	1	
Complimentary tickets to conference banquet	6	4	3	2	1
Number of people to man the exhibition booths with complementary lunch and tea break tickets	16	10	6	3	2